

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	99	mask same (insulating or insulator) and (droplet with discharge) and planarization and (gate with insulating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/25 11:38
S2	50	mask same (insulating or insulator) and ((droplet with discharge) same wiring) and planarization and (gate with insulating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/25 11:39
S3	1	"10/554113"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/25 13:56
S4	9	("20020053881" "20020136829" "5084905" "6416583" "6426595" "6627263").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/25 14:12
S5	3	("20020053881" "20020136829" "5084905" "6416583" "6426595" "6627263").PN. and (drop or jet or droplet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/25 14:13
S6	0	"WO 02/067335 A1"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 13:59

S7	1	"WO 02067335 A1"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 13:59
S8	2	"6952036".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 14:00
S9	82	(electroless adj plating) with (drop or droplet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 15:38
S10	0	(electroless adj plating) with (by adj (drop or droplet))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 15:40
S11	40	(electroless adj plating) with (droplet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/26 15:41
S12	1	"10/579443"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:02
S13	4404	(first adj solvent) with (second adj solvent)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:09

S14	21	(first adj solvent) with (second adj solvent) same mask	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:10
S15	11	(first adj solvent) with (second adj solvent) same mask and (nozzle or discharge or drop or droplet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:10
S16	19	planarization same heat same press	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:33
S17	16867	(257/57,59,66,72,776.ccls. 438/149,151,157,166,128,48,283,280,619.ccls.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:58
S18	99	mask same (insulating or insulator) and (droplet with discharge) and planarization and (gate with insulating)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:58
S19	20	S17 and S18	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/11/28 12:58

11/28/08 1:01:45 PM

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